

11.15 OA (2x) 7.6 Cu (2x) 4.1 0.6 Cu 1 SP (8x) 0.4 SP (2x) e = 0.5 8.63 OA (4x) 1 SP (10x) 0.4 SP 0.6 Cu 0.4 SP 0.28 Cu (68x) 8.9 Cu (2x) 10.8 Cu (2x) 0.5 SP (4x) 0.9 SP (10x)

MGW820

Legend:

- solder lands
- Cu pattern
- clearance
- solder paste
- occupied area

Dimensions in mm.